

# 16-Ch/Dual 8-Ch High-Performance CMOS Analog Multiplexers

#### **DESCRIPTION**

The DG406 is a 16 channel single-ended analog multiplexer designed to connect one of sixteen inputs to a common output as determined by a 4-bit binary address. The DG407 selects one of eight differential inputs to a common differential output. Break-before-make switching action protects against momentary shorting of inputs.

An on channel conducts current equally well in both directions. In the off state each channel blocks voltages up to the power supply rails. An enable (EN) function allows the user to reset the multiplexer/demultiplexer to all switches off for stacking several devices. All control inputs, address (A<sub>x</sub>) and enable (EN) are TTL compatible over the full specified operating temperature range.

Applications for the DG406, DG407 include high speed data acquisition, audio signal switching and routing, ATE systems, and avionics. High performance and low power dissipation make them ideal for battery operated and remote instrumentation applications.

Designed in the 44 V silicon-gate CMOS process, the absolute maximum voltage rating is extended to 44 V. allowing operation with ± 20 V supplies. Additionally single (12 V) supply operation is allowed. An epitaxial layer prevents latchup.

For applications information please request documents 70601 and 70604.

#### **FEATURES**

- Low on-resistance  $R_{DS(on)}$ : 50  $\Omega$
- Low charge injection Q: 15 pC
- Fast transition time t<sub>TRANS</sub>: 200 ns
- Low power: 0.2 mW
- Single supply capability
- 44 V supply max. rating
- · Material categorization:

For definitions of compliance please www.vishav.com/doc?99912





HALOGEN FREE

#### Note

This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information/tables in this datasheet for details.

#### **BENEFITS**

- Higher accuracy
- Reduced glitching
- Improved data throughput
- Reduced power consumption
- Increased ruggedness
- Wide supply ranges: ± 5 V to ± 20 V

#### **APPLICATIONS**

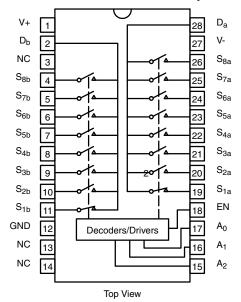
- · Data acquisition systems
- Audio signal routing
- · Medical instrumentation
- ATE systems
- · Battery powered systems
- · High-rel systems
- Single supply systems

### FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

**Dual-In-Line and SOIC Wide-Body** D V+ 28 NC V-2 NC  $S_8$  $S_{16}$ S<sub>7</sub> S<sub>15</sub>  $S_6$  $S_{14}$  $S_5$ 23 6 S<sub>13</sub>  $S_4$ 7  $S_3$  $S_{12}$ 8 S<sub>11</sub> 20  $S_2$ 9 S<sub>10</sub> S<sub>1</sub> Sg ΕN 18 GND  $A_0$ 12 17 Decoders/Drivers NC A۱ 16  $A_3$ Aρ

Top View

**DG407 Dual-In-Line and SOIC Wide-Body** 

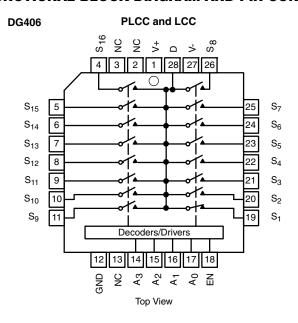


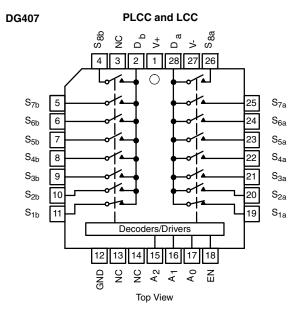
Document Number: 70061

**DG406** 



#### **FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION**





TRUTH	TRUTH TABLE (DG406)						
A <sub>3</sub>	A <sub>2</sub>	<b>A</b> <sub>1</sub>	<b>A</b> <sub>0</sub>	EN	ON SWITCH		
Х	Х	Х	Х	0	None		
0	0	0	0	1	1		
0	0	0	1	1	2		
0	0	1	0	1	3		
0	0	1	1	1	4		
0	1	0	0	1	5		
0	1	0	1	1	6		
0	1	1	0	1	7		
0	1	1	1	1	8		
1	0	0	0	1	9		
1	0	0	1	1	10		
1	0	1	0	1	11		
1	0	1	1	1	12		
1	1	0	0	1	13		
1	1	0	1	1	14		
1	1	1	0	1	15		
1	1	1	1	1	16		

TRUTH	TRUTH TABLE (DG407)						
A <sub>2</sub>	A <sub>1</sub>	$A_0$	EN	ON SWITCH PAIR			
Х	Х	Χ	0	None			
0	0	0	1	1			
0	0	1	1	2			
0	1	0	1	3			
0	1	1	1	4			
1	0	0	1	5			
1	0	1	1	6			
1	1	0	1	7			
1	1	1	1	8			

#### Notes

- Logic "0" = V<sub>AL</sub> ≤ 0.8 V
- Logic "1" = V<sub>AH</sub> ≥ 2.4 V
- X = Do not Care

ORDERING INFORMATION (DG406)					
TEMP. RANGE	PACKAGE	PART NUMBER			
	28-Pin Plastic DIP	DG406DJ, DG406DJ-E3			
-40 °C to 85 °C	28-Pin PLCC	DG406DN, DG406DN-T1-E3			
	28-Pin Widebody SOIC	DG406DW, DG406DW-E3, DG406DW-T1-E3			

ORDERING INFORMATION (DG407)					
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	28-Pin Plastic DIP	DG407DJ, DG407DJ-E3			
-40 °C to 85 °C	28-Pin PLCC	DG407DN, DG407DN-T1-E3			
	28-Pin Widebody SOIC	DG407DW, DG407DW-E3, DG407DW-T1-E3			

#### Note

• -T1 indicates Tape and Reel, -E3 indicates Lead-Free and RoHS Compliant, NO -E3 indicates standard Tin/Lead finish.



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ABSOLUTE MAXIMUM RATINGS					
PARAMETER		LIMIT	UNIT		
Voltages Referenced to V-	V+ to V -f	44			
voltages Referenced to v-	GND to V-	-25	7 v		
Digital Inputs <sup>a</sup> , V <sub>S</sub> , V <sub>D</sub>		(V-) - 2 to (V+) + 2 V or 20 mA, whichever occurs first			
Current (Any terminal)		30	mA		
Peak Current, S or D (Pulsed at 1 r	ns, 10 % duty cycle max.)	100			
Storage Temperature	(AK, AZ Suffix)	-65 to 150	°C		
Storage Temperature	(DJ, DN Suffix)	-65 to 125			
	28-Pin Plastic DIPb	625			
Power Dissipation (Package)b	28-Pin Plastic PLCCc	450	mW		
	28-Pin Widebody SOIC	450			

#### Notes

- a. Signals on SX, DX or INX exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads soldered or welded to PC board.
- c. Derate 6 mW/°C above 75 °C.
- d. Derate 12 mW/°C above 75 °C.
- e. Derate 13.5 mW/°C above 75 °C.
- f. Also applies when V- = GND





SPECIFICATIONS <sup>a</sup>		TEST CONDITION	ONS			n ei	JFFIX	
PARAMETER	SYMBOL	UNLESS OTHER SPECIFIED	WISE	TEMP.b	TYP.º	-40 °C TO 85 °C		UNIT
PARAMETER	STMBOL	V+ = 15 V, V- = -15 V V <sub>AL</sub> = 0.8 V, V <sub>AH</sub> = 2.4 V <sup>f</sup>		I EIVIP."	TTP.	MIN.d	MAX.d	UNIT
Analog Switch						l		<u> </u>
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>			Full	-	-15	15	V
Drain-Source	_	$V_D = \pm 10 \text{ V}, I_S = -$	10 mA	Room	50	-	100	
On-Resistance	R <sub>DS(on)</sub>	sequence each sw	itch on	Full	50	-	125	Ω
R <sub>DS(on)</sub> Matching Between Channels <sup>g</sup>	$\Delta R_{DS(on)}$	V <sub>D</sub> = ± 10 V		Room	5	-	-	%
Source Off Leakage Current	I <sub>S(off)</sub>			Room	0.01	-0.5	0.5	
Source on Lounage Garrent	•5(оп)	., .,		Full	0.01	-5	5	
		$V_{EN} = 0 V$ $V_{D} = \pm 10 V$	DG406	Room	0.04	-1	1	
Drain Off Leakage Current	lov m	$V_{S} = \pm 10 \text{ V}$	Datoo	Full	0.04	-40	40	
Drain on Leanage Garrent	I <sub>D(off)</sub>		DG407	Room	0.04	-1	1	nA
			Dator	Full	0.04	-20	20	
		V V 15	DG406	Room	0.04	-1	1	
Drain On Leakage Current	l <sub>n/</sub> .	$V_S = V_D = \pm 10$ sequence each	DG400	Full	0.04	-40	40	
Diain On Leakage Guirein	I <sub>D(on)</sub>	switch on	DG407	Room	0.04	-1	1	
			DQ407	Full	0.04	-20	20	
Digital Control								
Logic High Input Voltage	V <sub>INH</sub>			Full	-	2.4	-	V
Logic Low Input Voltage	V <sub>INL</sub>			Full	-	-	0.8	]
Logic High Input Current	I <sub>AH</sub>	V <sub>A</sub> = 2.4 V, 15	V	Full	-	-1	1	
Logic Low Input Current	I <sub>AL</sub>	$V_{EN} = 0 \text{ V}, 2.4 \text{ V}, \text{ V}$	<sub>A</sub> = 0 V	Full	-	-1	1	μA
Logic Input Capacitance	C <sub>in</sub>	f = 1 MHz		Room	7	-	-	pF
Dynamic Characteristics								
Transition Time	<b>+</b>	see figure 2		Room	200	-	350	
Transition fille	t <sub>TRANS</sub>	See figure 2		Full	-	-	450	
Break-Before-Make Interval	+	see figure 4		Room	50	25	-	
bleak-belole-iviake lillerval	t <sub>OPEN</sub>	See ligure 4		Full	-	10	-	] no
Frankla Turn On Times				Room	150	-	200	ns
Enable Turn-On Time	t <sub>ON(EN)</sub>	fin 0	•	Full	-	-	400	1
Enable Turn-Off Time		see figure 3	•	Room	70	-	150	1
Enable Turn-Off Time	t <sub>OFF(EN)</sub>		•	Full	-	-	300	1
Charge Injection	Q	$V_S = 0 V, C_L = 1 nF,$	$R_S = 0 \Omega$	Room	15	-	-	рС
Off Isolation <sup>h</sup>	OIRR	$V_{EN} = 0 \text{ V, R}_{L} = 0 \text{ f} = 100 \text{ kHz}$	1 kΩ	Room	-69	-	-	dB
Source Off Capacitance	C <sub>S(off)</sub>	$V_{EN} = 0 \text{ V}, V_{S} = 0 \text{ V}, f$	= 1 MHz	Room	8	-	-	
D:- Off Cit				Room	130	-	-	1
Drain Off Capacitance	$C_{D(off)}$	$V_{EN} = 0 V$	DG407	Room	65	-	-	pF
D : 0 0 "		$V_D = 0 V$ f = 1 MHz	DG406	Room	140	-	-	1
Drain On Capacitance	C <sub>D(on)</sub>	1 – 1 1411 12	DG407	Room	70	-	-	
Power Supplies						•		
Positive Supply Current	I+			Room	13	-	30	
r ositive oupply ourretit	1+	$V_{FN} = V_A = 0$ or	5 V	Full	-	-	75	
Mogative Supply Current	1	$v_{EN} = v_A = 0$ or	JV	Room	-0.01	-1	-	1
Negative Supply Current	I-		ļ	Full	-	-10	-	
Desitive County County				Room	50	-	500	μA
Positive Supply Current	l+	.,	2.14	Full		-	700	1
	_	$V_{EN} = 2.4 \text{ V}, V_A = 0 \text{ V}$		Room	-0.01	-20	-	- -
Negative Supply Current	I-			Full	-0.01	-20		



SPECIFICATIONS <sub>a</sub> (for Single Supply)								
DADAMETED	O)(MADO)	$\begin{tabular}{c c} TEST CONDITIONS \\ UNLESS OTHERWISE \\ SPECIFIED \\ V+=12\ V, V-=0\ V \\ V_{AL}=0.8\ V, V_{AH}=2.4\ V^f \\ \end{tabular}$		h		D SUFFIX -40 °C TO 85 °C		
PARAMETER	SYMBOL			TEMP.b	TYP.º	MIN.d	MAX.d	UNIT
Analog Switch						•	•	
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>			Full	-	0	12	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>D</sub> = 3 V, 10 V, I <sub>S</sub> =	-1 mA	Room	90	-	120	Ω
R <sub>DS(on)</sub> Matching Between Channels <sup>g</sup>	$\Delta R_{DS(on)}$	sequence each switch on		Room	5	-	-	%
Source Off Leakage Current	I <sub>S(off)</sub>	V <sub>EN</sub> = 0 V		Room	0.01	-	-	
Dunin Off Looks as Comment	,	$V_D = 10 \text{ V or } 0.5 \text{ V}$	DG406	Room	0.04	-	-	nA
Drain Off Leakage Current	I <sub>D(off)</sub>	$V_S = 0.5 \text{ V or } 10 \text{ V}$	DG407	Room	0.04	-	-	
	_	$V_S = V_D = \pm 10 \text{ V}$ $I_{D(on)}$ sequence each switch on	DG406	Room	0.04	-	-	
Drain On Leakage Current	I <sub>D(on)</sub>		DG407	Room	0.04	-	-	
Dynamic Characteristics								
Switching Time of Multiplexer	t <sub>OPEN</sub>	$V_{S1} = 8 \text{ V}, V_{S8} = 0 \text{ V}, V_{S8}$	<sub>IN</sub> = 2.4 V	Room	300	-	450	
Enable Turn-On Time	t <sub>ON(EN)</sub>	$V_{INH} = 2.4 \text{ V}, V_{INL}$	= 0 V	Room	250	-	600	ns
Enable Turn-Off Time	t <sub>OFF(EN)</sub>	$V_{S1} = 5 V$		Room	150	-	300	
Charge Injection	Q	$C_L = 1 \text{ nF}, V_S = 6 \text{ V},$	$R_S = 0$	Room	20	-	-	рС
Power Supplies	Power Supplies							
Positive Supply Current	l+			Room	13	-	30	
1 Ositive Supply Surrent	17	$V_{FN} = 0 \text{ V or 5 V, V}_{A} =$	0 V or 5 V	Full	-	-	75	μΑ
Negative Supply Current	I-	V <sub>EN</sub> - 0 V OI 3 V, V <sub>A</sub> =	0 1 01 0 1	Room	-0.01	-20	-	
140gative Supply Surrent	'			Full	-0.01	-20	-	

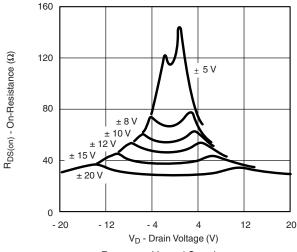
#### Notes

- a. Refer to PROCESS OPTION FLOWCHART.
- b. Room = 25 °C, Full = as determined by the operating temperature suffix.
- c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- e. Guaranteed by design, not subject to production test.
- f.  $V_{IN}$  = input voltage to perform proper function.
- g.  $\Delta R_{DS(on)} = R_{DS(on)} \text{ max.} R_{DS(on)} \text{ min.}$
- h. Worst case isolation occurs on Channel 4 due to proximity to the drain pin.

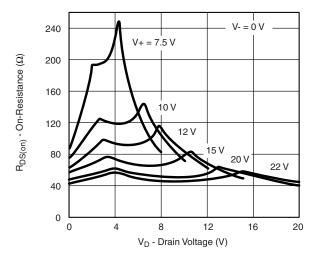
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



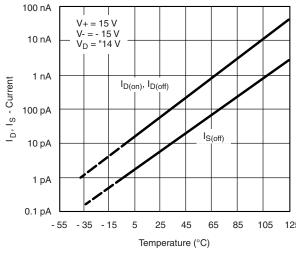
# **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)





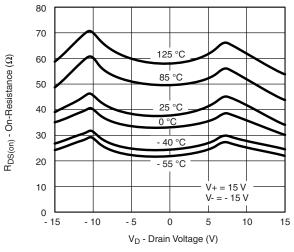


R<sub>DS(on)</sub> vs. V<sub>D</sub> and Supply

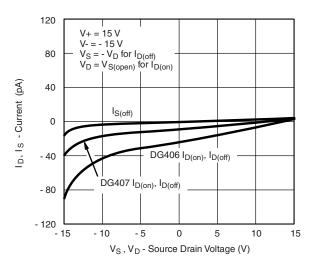


I<sub>D</sub>, I<sub>S</sub> Leakages vs. Temperature

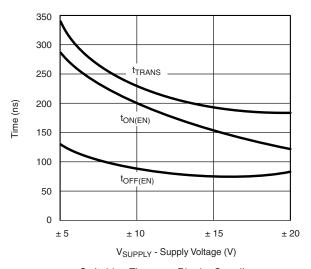
S13-2518-Rev. K, 09-Dec-13



R<sub>DS(on)</sub> vs. V<sub>D</sub> and Temperature



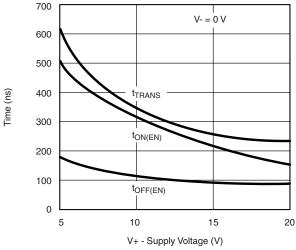
I<sub>D</sub> , I<sub>S</sub> Leakage Currents vs. Analog Voltage

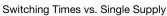


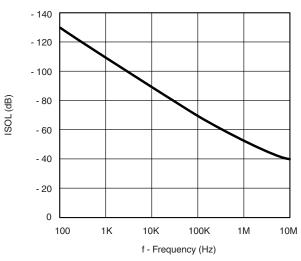
Switching Times vs. Bipolar Supplies



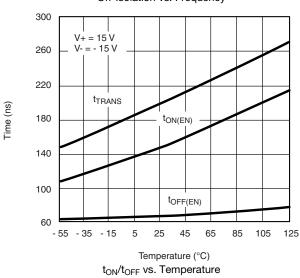
# **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

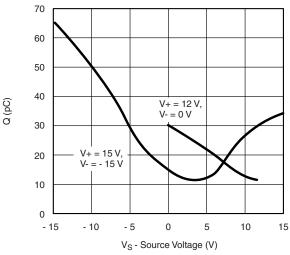




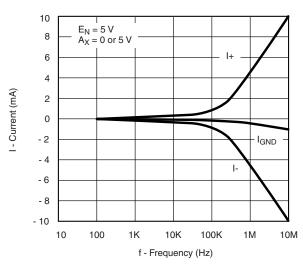


### Off-Isolation vs. Frequency

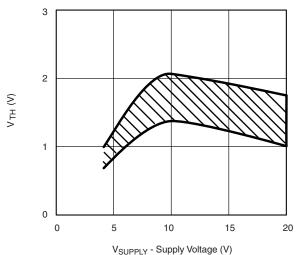




Charge Injection vs. Analog Voltage



Supply Currents vs. Switching Frequency



Switching Threshold vs. Supply Voltage



### **SCHEMATIC DIAGRAM** (Typical Channel)

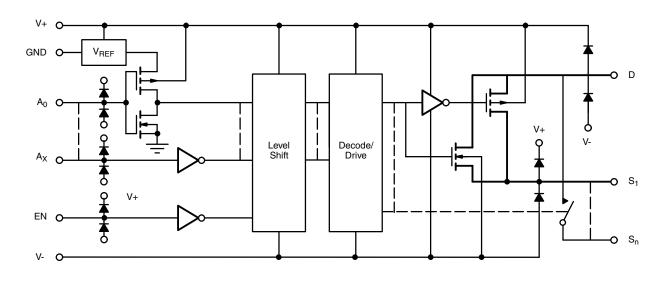


Fig. 1

#### **TEST CIRCUITS**

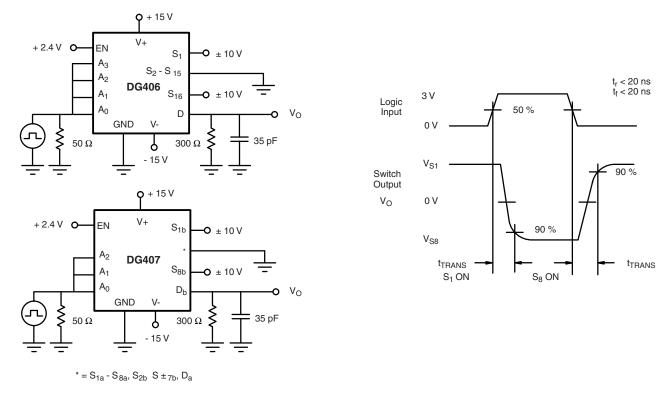


Fig. 2 - Transition Time

### **TEST CIRCUITS**

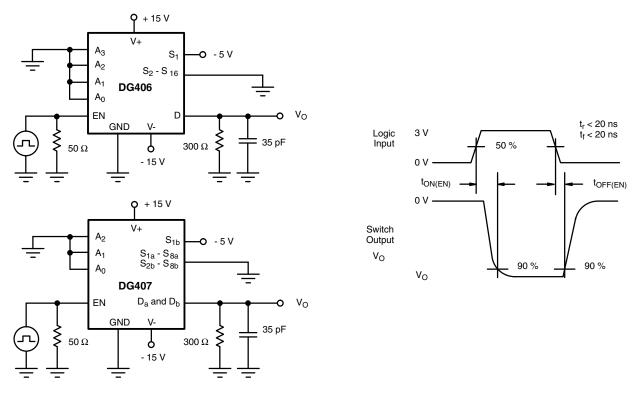


Fig. 3 - Enable Switching Time

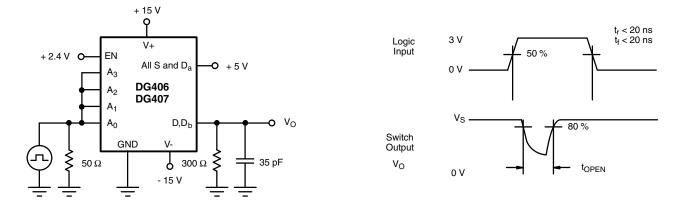


Fig. 4 - Break-Before-Make Interval

#### **APPLICATIONS HINTS**

Sampling speed is limited by two consecutive events: the transition time of the multiplexer, and the settling time of the sampled signal at the output.

 $t_{TRANS}$  is given on the data sheet. Settling time at the load depends on several parameters:  $R_{DS(on)}$  of the multiplexer, source impedance, multiplexer and load capacitances, charge injection of the multiplexer and accuracy desired.

The settling time for the multiplexer alone can be derived from the model shown in figure 5. Assuming a low impedance signal source like that presented by an op amp or a buffer amplifier, the settling time of the RC network for a given accuracy is equal to  $n\tau$ :

% ACCURACY	# BITS	N
0.25	8	6
0.012	12	9
0.0017	15	11

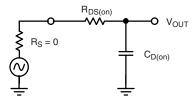


Fig. 5 - Simplified Model of One Multiplexer Channel

The maximum sampling frequency of the multiplexer is:

$$f_s = \frac{1}{N(t_{SETTLING} + t_{TRANS})} (1)$$

where N = number of channels to scan  $t_{SETTLING} = n\tau = n~x~R_{DS(on)}~x~C_{D(on)}$ 

For the DG406 then, at room temp and for 12-bit accuracy, using the maximum limits:

$$f_s = \frac{1}{16(9 \times 100 \ \Omega \times 10^{-12} \text{F}) + 300 \times 10^{-12} \text{s}}$$
 (2)

or

$$f_s = 694 \text{ kHz} \tag{3}$$

From the sampling theorem, to properly recover the original signal, the sampling frequency should be more than twice the maximum component frequency of the original signal. This assumes perfect bandlimiting. In a real application sampling at three to four times the filter cutoff frequency is a good practice.

Therefore from equation 2 above:

$$f_c = \frac{1}{4} \times f_s = 173 \text{ kHz} \tag{4}$$

From this we can see that the DG406 can be used to sample 16 different signals whose maximum component frequency can be as high as 173 kHz. If for example, two channels are used to double sample the same incoming signal then its cutoff frequency can be doubled.

The block diagram shown in figure 6 illustrates a typical data acquisition front end suitable for low-level analog signals. Differential multiplexing of small signals is preferred since this method helps to reject any common mode noise. This is especially important when the sensors are located at a distance and it may eliminate the need for individual amplifiers. A low  $R_{DS(on)}$ , low leakage multiplexer like the DG407 helps to reduce measurement errors. The low power dissipation of the DG407 minimizes on-chip thermal gradients which can cause errors due to temperature mismatch along the parasitic thermocouple paths. Please refer to Application Note AN203 for additional information.

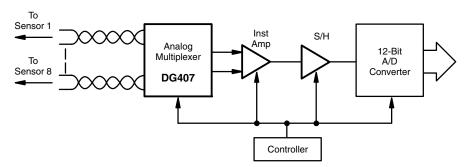
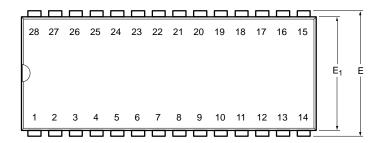


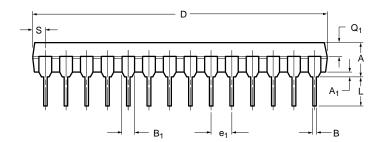
Fig. 6 - Measuring Low-Level Analog Signals is more accurate when using a Differential Multiplexing Technique

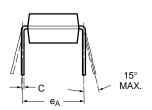
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PDIP: 28-LEAD





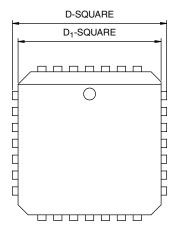


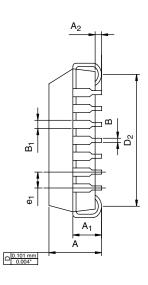
	MILLIM	IETERS	INC	HES
Dim	Min	Max	Min	Max
A	2.29	5.08	0.090	0.200
A <sub>1</sub>	0.39	1.77	0.015	0.070
В	0.38	0.56	0.015	0.022
B <sub>1</sub>	0.89	1.65	0.035	0.065
C	0.204	0.30	0.008	0.012
D	35.10	39.70	1.380	1.565
E	15.24	15.88	0.600	0.625
E <sub>1</sub>	13.21	14.73	0.520	0.580
e <sub>1</sub>	2.29	2.79	0.090	0.110
eA	14.99	15.49	0.590	0.610
L	2.60	5.08	0.100	0.200
Q <sub>1</sub>	0.95	2.345	0.0375	0.0925
S	0.995	2.665	0.0375	0.105

ECN: S-03946—Rev. F, 09-Jul-01 DWG: 5488



# **PLCC: 28-LEAD**



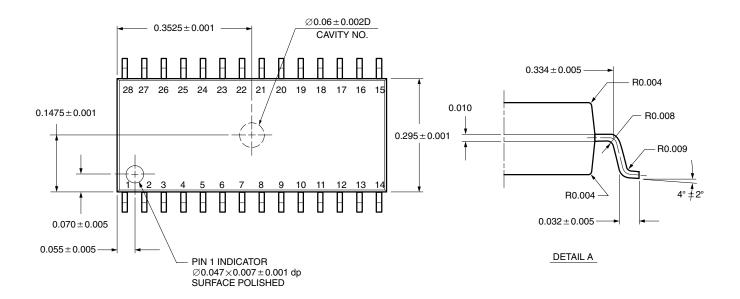


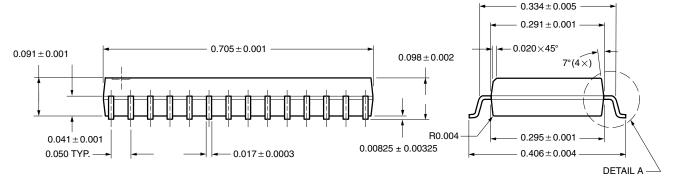
DIM.	MILLIN	METERS	INC	HES		
	MIN.	MAX.	MIN.	MAX.		
Α	4.20	4.57	0.165	0.180		
A <sub>1</sub>	2.29	3.04	0.090	0.120		
A <sub>2</sub>	0.51	-	0.020	-		
В	0.331	0.553	0.013	0.021		
B <sub>1</sub>	0.661	0.812	0.026	0.032		
D	12.32	12.57	0.485	0.495		
D <sub>1</sub>	11.430	11.582	0.450	0.456		
D <sub>2</sub>	9.91	10.92	0.390	0.430		
e <sub>1</sub>	1.27	BSC	0.050	BSC		
ECNI. TOO	FCN: T00 0766 Pay D 20 Can 00					

ECN: T09-0766-Rev. D, 28-Sep-09 DWG: 5491



### **SOIC (WIDE-BODY): 28-LEADS**





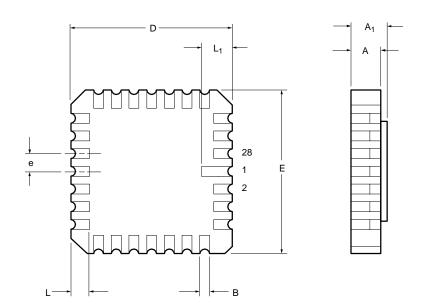
All Dimensions In Inches

ECN: E11-2209-Rev. D, 01-Aug-11

DWG: 5850



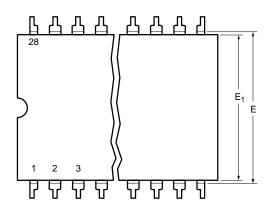
# 28-LEAD LCC

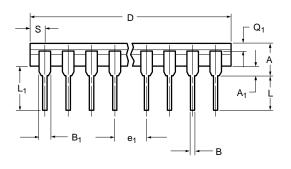


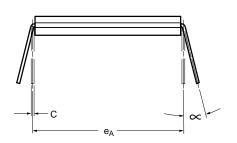
	MILLIM	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
A	1.37	2.24	0.054	0.088	
A <sub>1</sub>	1.63	2.54	0.064	0.100	
В	0.56	0.71	0.022	0.028	
D	11.23	11.63	0.442	0.458	
E	11.23	11.63	0.442	0.458	
е	1.27	BSC	0.050	BSC	
L	1.14	1.40	0.045	0.055	
L <sub>1</sub>	1.96	2.36	0.077	0.093	
ECN: S-03946—Rev. B, 09-Jul-01 DWG: 5319					



### **CERDIP: 28-LEAD**







	MILLIMETERS		INC	HES	
Dim	Min	Max	Min	Max	
Α	4.06	5.92	0.160	0.232	
A <sub>1</sub>	0.38	1.52	0.015	0.060	
В	0.38	0.51	0.015	0.020	
B <sub>1</sub>	1.14	1.65	0.045	0.065	
С	0.20	0.30	0.008	0.012	
D	36.58	37.08	1.440	1.460	
E	15.24	15.88	0.600	0.625	
E <sub>1</sub>	12.95	13.46	0.510	0.530	
e <sub>1</sub>	2.54	BSC	0.100	BSC	
e <sub>A</sub>	15.24	BSC	0.600 BSC		
L	3.18	3.81	0.125	0.150	
L <sub>1</sub>	3.81	5.08	0.150	0.200	
$Q_1$	1.27	2.16	0.050	0.085	
S	1.52	2.29	0.060	0.090	
∞	0°	15°	0°	15°	
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5434					

Document Number: 71283 www.vishay.com 03-Jul-01 www.vishay.com



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

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